



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

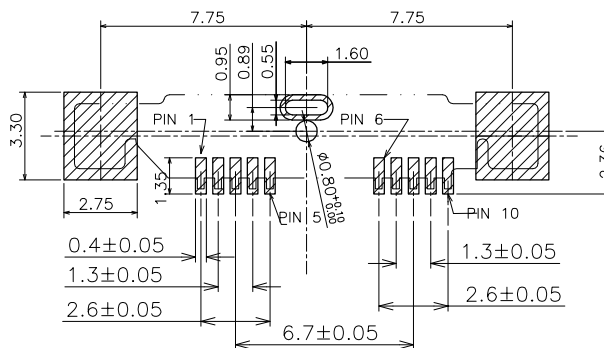
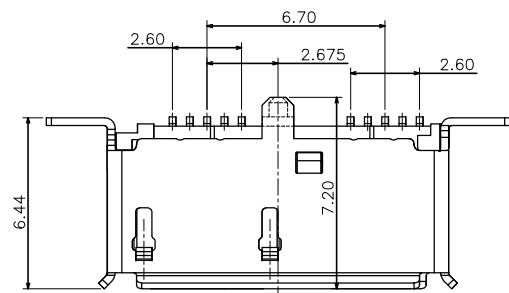
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



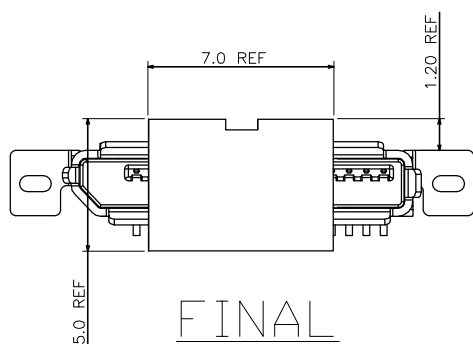
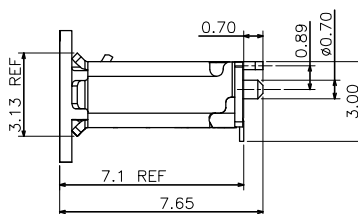
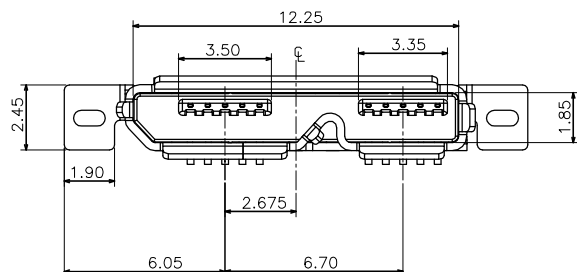
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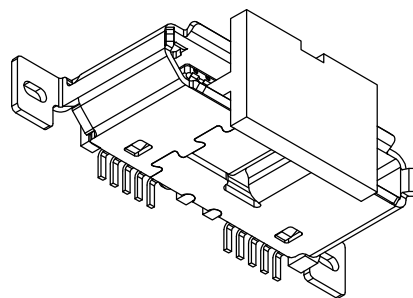


NOTES:

- MACHANICAL CHARACTERISTICS:
 MATING FORCE: 1.30±0.30kgf.
 UNMATING FORCE: 1.30±0.30kgf.
 DURABILITY: 10000 CYCLES
- ELECTRICAL CHARACTERISTICS:
 CURRENT RATING:1.5A
 CONTACT RESISTANCE:30mΩMax.
 DIELECTRICAL WITHSTANDING:100V AC/1min.
 INSULATION RESISTANCE:100MΩ
- MATERIAL:
 PLASTIC:LCP WITH 30% GF,UL 94V-0 ,BLACK.
 TERMINAL:BRASS, T=0.15mm
 TERMINAL PLATING:
 50u" NICKEL UNDERPLATING OVER ALL,
 15u" GOLD PLATING ON THE CONTACT AREA
 100u" TIN PLATING ON THE SOLDER AREA
 SHIELD: STEEL 0.3 THICKNESS.
 SHIELD PLATING: 50~120u" NICKEL PLATING OVER ALL
- OTHERS:
 OPERATION TEMPERATURE: -20°C to +80°C



FINAL



DETACHED LISTS	MM (INCH)	DFTD Roy	DATE 11/20/2012		RoHS Compliant	
	TOLERANCES EXCEPT AS NOTED	CHKD	DATE			
	MM	±	APPVL	DATE	TITLE USB 3.0 Micro BF SMD SHORT BODY	
	.0 ± 0.35	±	MATERIAL :			
.0 ± 0.25	±	ANGLES: X*±1° X.X*±0.5°		DRAWING NO. E8110-033-01		
.00 ± 0.15	±	THIRD ANGLE PROJECTION		/PART NO. E8110-033-01		
.000 ± 0.05	±	SCALE : 1:1		SIZE A3		
DO NOT SCALE DRAWING				REV 01		
SHEET 1				OF 1		